

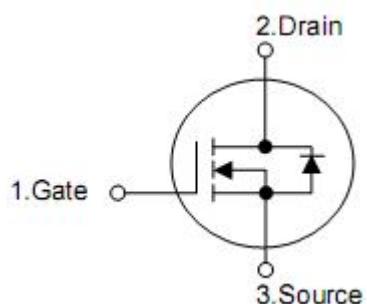
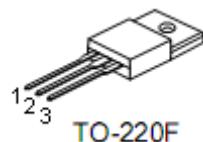
1. Description

This Power MOSFET is produced using KIA semi's advanced super-junction technology. This advanced technology has been especially tailored to minimize conduction loss, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for AC/DC power conversion in switching mode operation for higher efficiency.

2. Features

- $R_{DS(on)}=0.6\Omega$ @ $V_{GS}=10V$
- Low gate charge (typical 25nC)
- High ruggedness
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

3. Pin configuration



Pin	Function
1	Gate
2	Drain
3	Source

4. Absolute maximum ratings

($T_C = 25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-source voltage	V_{DSS}	650	V
Gate-source voltage	V_{GSS}	+30	V
Drain current continuous	I_D	7*	A
		5*	A
Drain current pulsed (note1)	I_{DM}	10*	A
Avalanche energy	Repetitive (note1)	43	mJ
	Single pulse (note2)	86	mJ
Avalanche energy(note1)	I_{AR}	1.7	A
Peak diode recovery dv/dt (note3)	dv/dt	4.5	V/ns
Total power dissipation	P_D	35	W
		0.3	W/ $^\circ\text{C}$
Operating and storage temperature range	T_J, T_{STG}	-55~+150	$^\circ\text{C}$
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	T_L	300	$^\circ\text{C}$

* Drain current limited by maximum junction temperature

5. Thermal characteristics

Parameter	Symbol	Rating	Unit
Thermal resistance, Junction-ambient	R_{thJA}	62	$^\circ\text{C/W}$
Thermal resistance, case-to-sink typ.	R_{thJS}	-	$^\circ\text{C/W}$
Thermal resistance, Junction-case	R_{thJC}	3.6	$^\circ\text{C/W}$

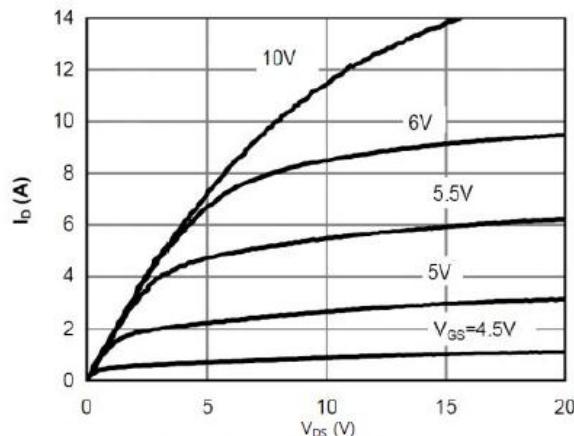
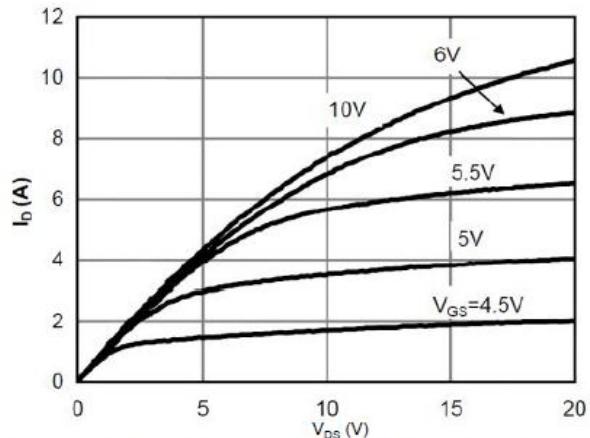
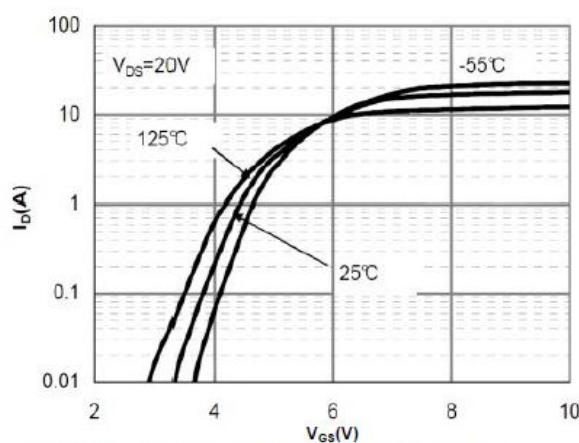
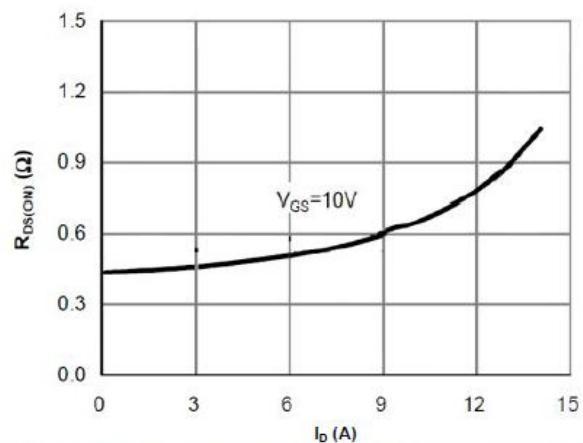
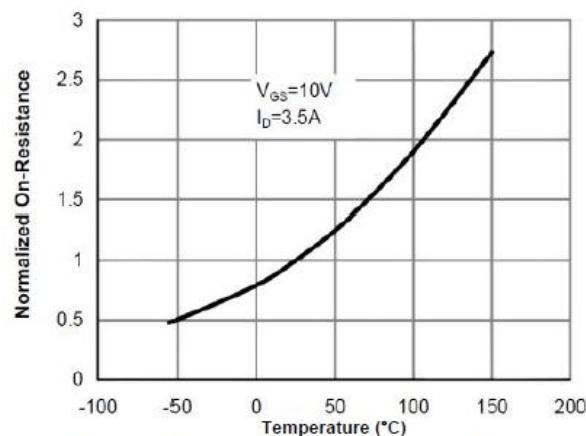
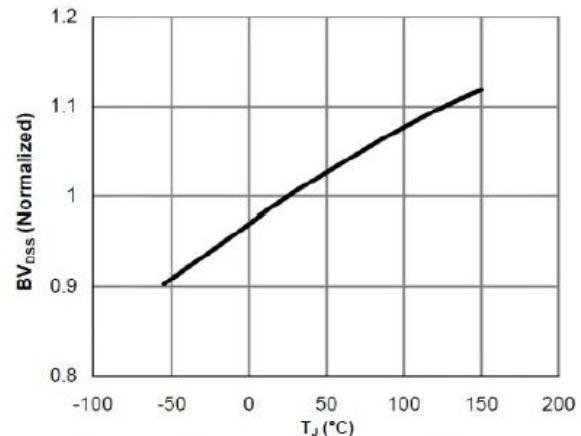
6. Electrical characteristics

($T_C=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	650	-	-	V
		$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	-	700	-	V
Zero gate voltage drain current	I_{DSS}	$V_{\text{DS}}=650\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	μA
		$V_{\text{DS}}=480\text{V}, T_C=125^\circ\text{C}$	-	-	10	μA
Gate-body leakage current	I_{GSS}	$V_{\text{GS}}=30\text{V}, V_{\text{DS}}=0\text{V}$	-	-	100	nA
		$V_{\text{GS}}=-30\text{V}, V_{\text{DS}}=0\text{V}$	-	-	-100	nA
Breakdown voltage temperature coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$I_{\text{D}}=250\mu\text{A}$, referenced to 25°C	-	0.6	-	$\text{V}/^\circ\text{C}$
On characteristics						
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.5	3.5	4.5	V
Static drain-source on-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=3.5\text{A}$	-	0.6	0.7	Ω
Forward transconductance	g_{FS}	$V_{\text{DS}}=40\text{V}, I_{\text{D}}=3.5\text{A}$ (note4)	-	16	-	S
Dynamic characteristics						
Input capacitance	C_{iss}	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	-	360	-	pF
Output capacitance	C_{oss}		-	25	-	pF
Reverse transfer capacitance	C_{rss}		-	1.2	-	pF
Switching characteristics						
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=400\text{V}, I_{\text{D}}=3.5\text{A}, R_G=20\Omega$ (note4,5)	-	25	-	ns
Rise time	t_r		-	55	-	ns
Turn-off delay time	$t_{\text{d}(\text{off})}$		-	70	-	ns
Fall time	t_f		-	40	-	ns
Total gate charge	Q_g	$V_{\text{DS}}=480\text{V}, I_{\text{D}}=7\text{A}, V_{\text{GS}}=10\text{V}$ (note4,5)	-	8	-	nC
Gate-source charge	Q_{gs}		-	2.0	-	nC
Gate-drain charge	Q_{gd}		-	2.7	-	nC
Drain-source diode characteristics and maximum ratings						
Drain-source diode forward voltage	V_{SD}	$V_{\text{GS}}=0\text{V}, I_{\text{SD}}=\text{A}$	-	-	1.5	V
Continuous drain-source current	I_s		-	-	7	A
Pulsed drain-source current	I_{SM}		-	-	18	A
Reverse recovery time	t_{rr}	$V_{\text{GS}}=0\text{V}, I_{\text{SD}}=7\text{A}$ $dI_F/dt=100\text{A}/\mu\text{s}$ (note4)	-	190	-	ns
Reverse recovery charge	Q_{rr}		-	2.3	-	μC

Note: 1. repetitive rating: pulse width limited by maximum junction temperature

2. $L=60\text{mH}, I_{\text{AS}}=1.7\text{A}, V_{\text{DD}}=150\text{V}$, starting $T_J=25^\circ\text{C}$
3. $I_{\text{SD}} \leq 7.0\text{A}, dI/dt \leq 200\text{A}/\mu\text{s}, V_{\text{DD}} \leq \text{BV}_{\text{DSS}}$, starting $T_J=25^\circ\text{C}$
4. Pulse test: pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
5. Essentially independent of operating temperature typical characteristics.

7. Test circuits and waveforms**Typical Characteristics****Figure 1: On-Region Characteristics@25°C****Figure 2: On-Region Characteristics@125°C****Figure 3: Transfer Characteristics****Figure 4: On-Resistance vs. Drain Current and Gate Voltage****Figure 5: On-Resistance vs. Junction Temperature****Figure 6: Break Down vs. Junction Temperature**

Typical Characteristics

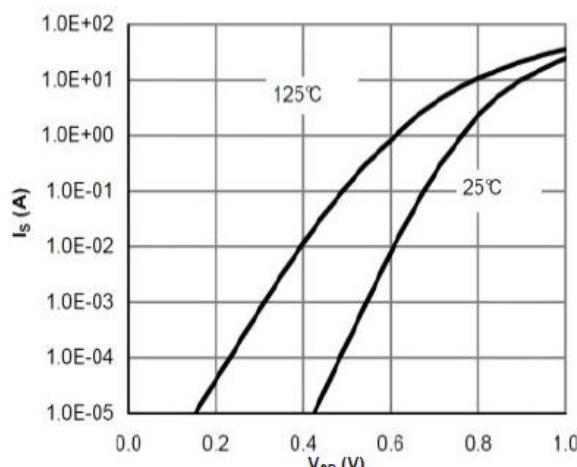


Figure 7: Body-Diode Characteristics

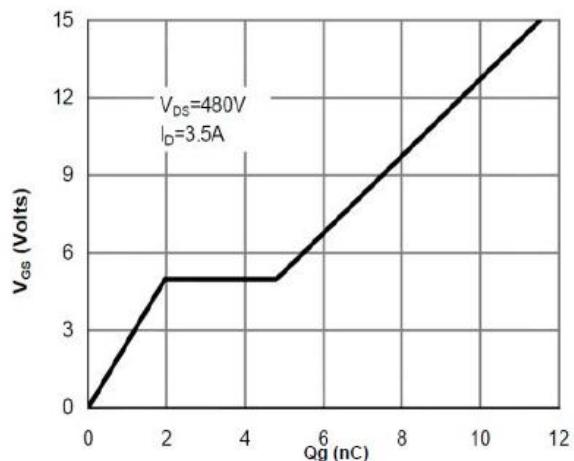


Figure 8: Gate-Charge Characteristics

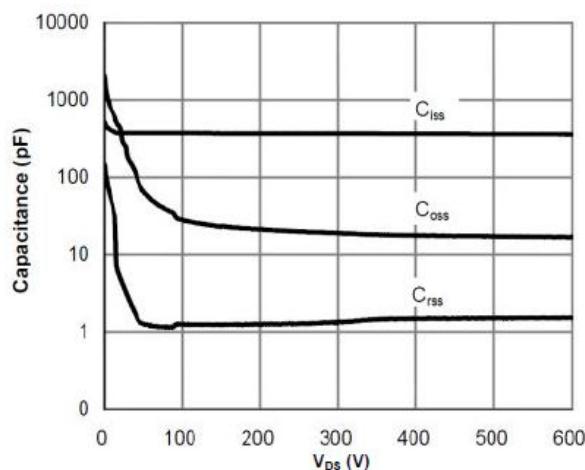


Figure 9: Capacitance Characteristics

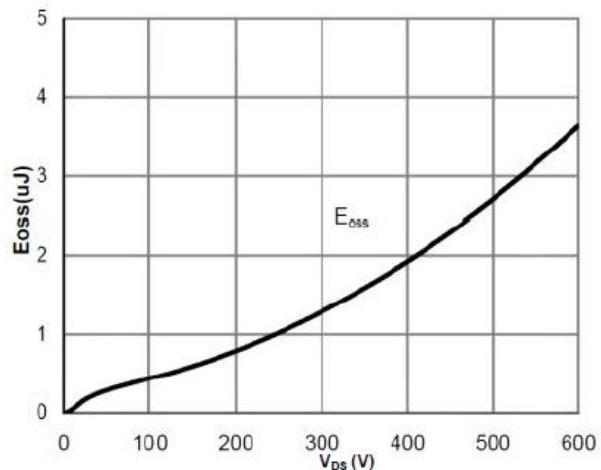


Figure 10: C_{oss} stored Energy

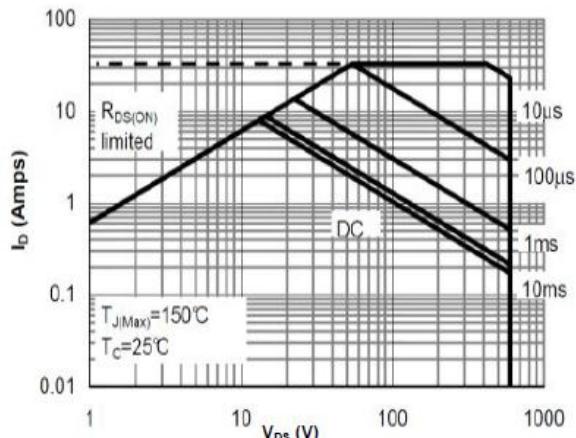


Figure 11: Maximum Forward Biased Safe Operating Area

Typical Characteristics

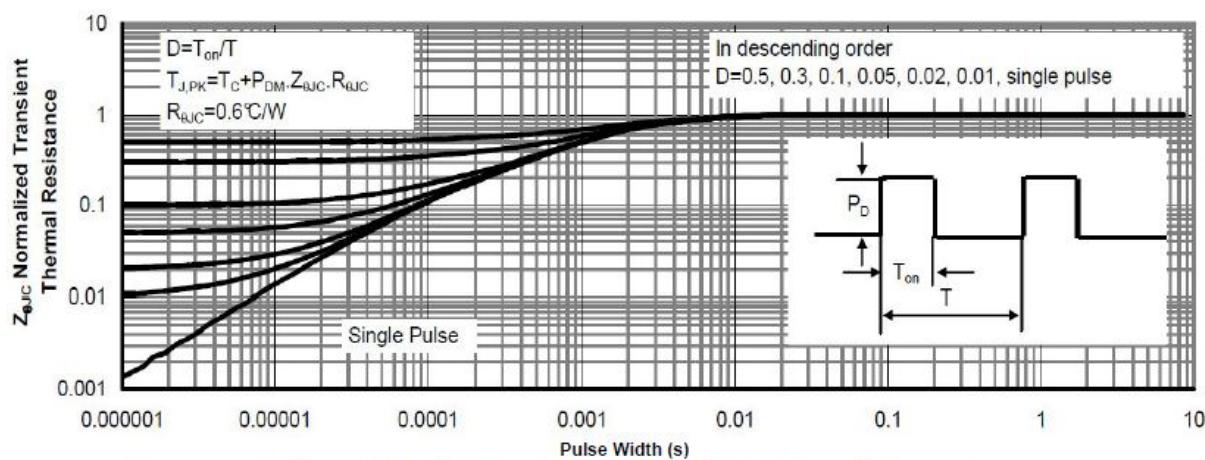


Figure 12: Normalized Maximum Transient Thermal Impedance

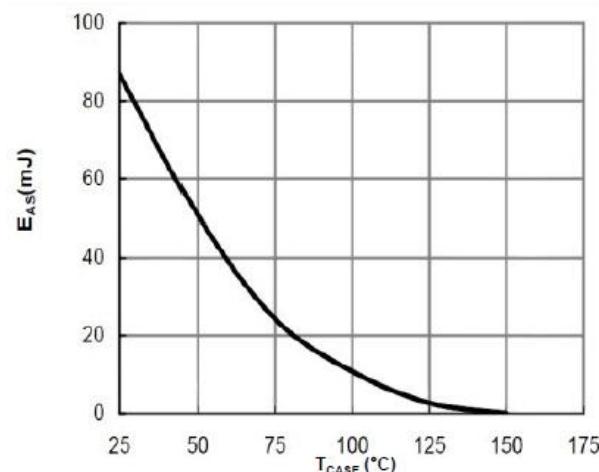


Figure 13: Avalanche energy

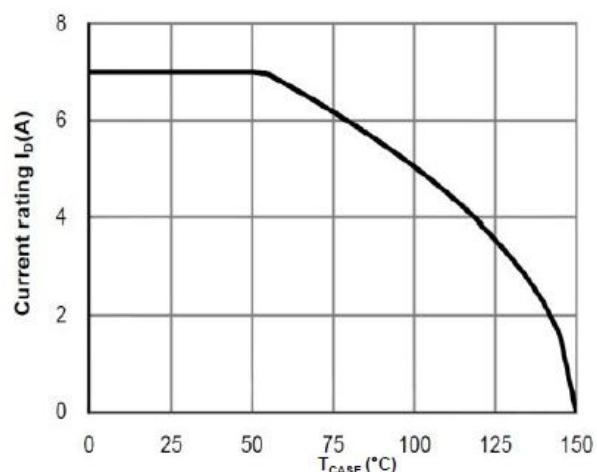


Figure 14: Current De-rating

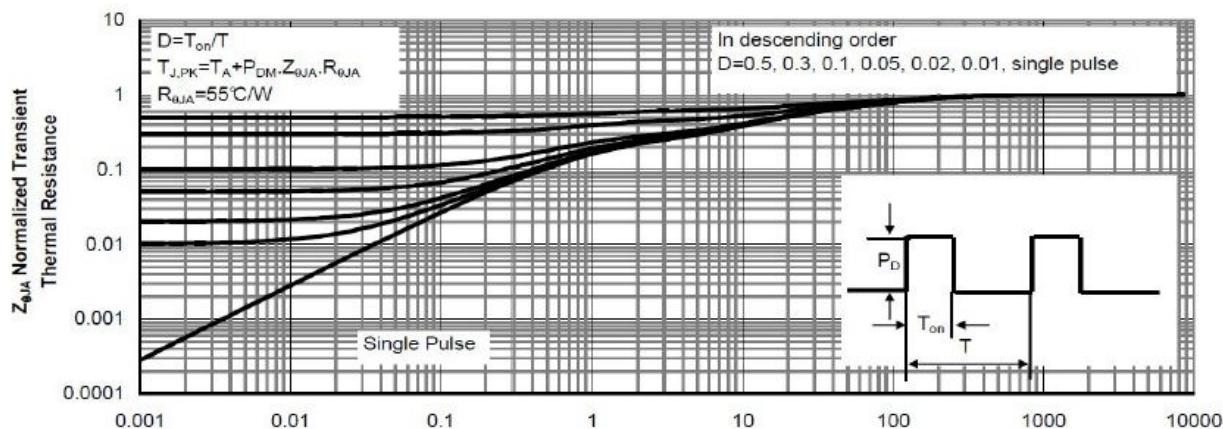


Figure 15: Normalized Maximum Transient Thermal Impedance

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by KIA manufacturer:

Other Similar products are found below :

[614233C](#) [648584F](#) [FDPF9N50NZ](#) [IRFD120](#) [IRFF430](#) [JANTX2N5237](#) [2N7000](#) [FCA20N60_F109](#) [FDZ595PZ](#) [2SK2267\(Q\)](#) [2SK2545\(Q,T\)](#)
[405094E](#) [423220D](#) [MIC4420CM-TR](#) [VN1206L](#) [614234A](#) [715780A](#) [SSM6J414TU,LF\(T\)](#) [751625C](#) [PSMN4R2-30MLD](#)
[TK31J60W5,S1VQ\(O\)](#) [2SK2614\(TE16L1,Q\)](#) [DMN1017UCP3-7](#) [EFC2J004NUZTDG](#) [FCAB21350L1](#) [P85W28HP2F-7071](#) [DMN1053UCP4-7](#)
[NTE2384](#) [NTE2969](#) [NTE6400A](#) [DMN61D9UWQ-13](#) [US6M2GTR](#) [DMN31D5UDJ-7](#) [SSM6P54TU,LF](#) [DMP22D4UFO-7B](#)
[IPS60R3K4CEAKMA1](#) [DMN1006UCA6-7](#) [DMN16M9UCA6-7](#) [STF5N65M6](#) [STU5N65M6](#) [C3M0021120D](#) [DMN13M9UCA6-7](#)
[BSS340NWH6327XTSA1](#) [MCM3400A-TP](#) [DMTH10H4M6SPS-13](#) [IPS60R1K0PFD7SAKMA1](#) [IPS60R360PFD7SAKMA1](#)
[IPS60R600PFD7SAKMA1](#) [IPS60R210PFD7SAKMA1](#) [DMN2990UFB-7B](#)